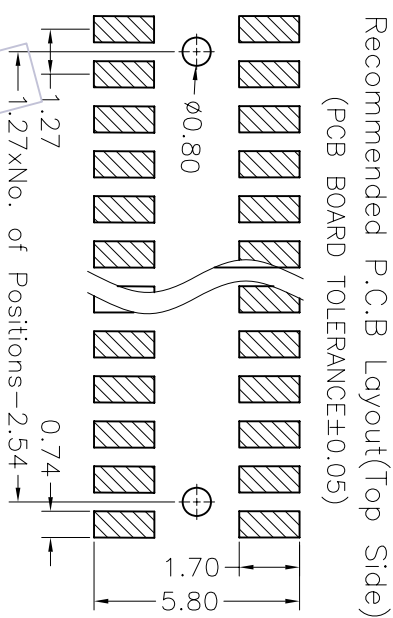
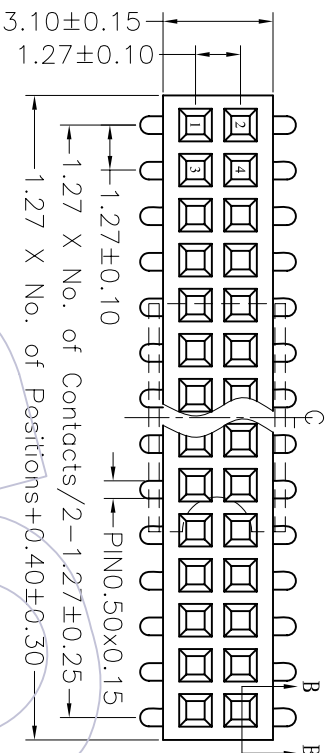


# HSP

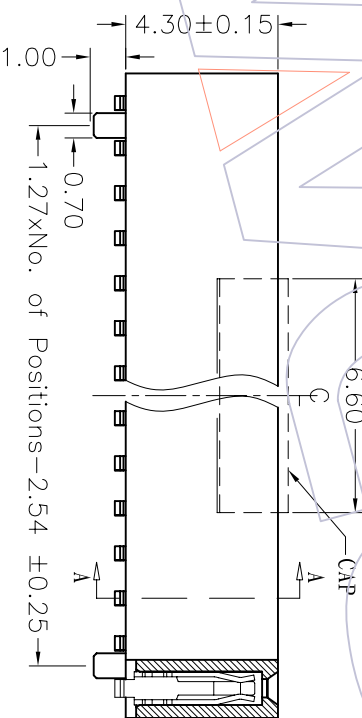
NOTES:  
 Current Rating: 1.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 100MΩMin  
 Operation Temperature: -40°C to +105°C  
 Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G. F UL94V-0



## Ordering Information

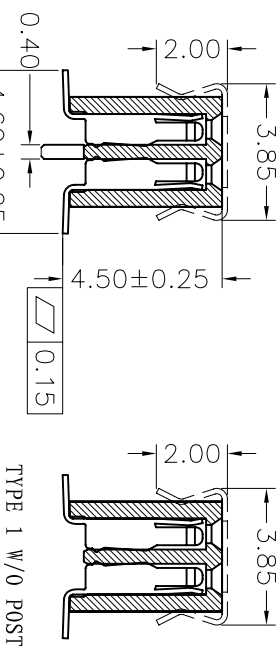
2344 - 2 XX M XX CUNT X

No. of Pins per ROW: 02-50PIN  
 Contact Plating: G1=Gold Flash, G2=5μ Gold, G3=10μ Gold, G4=50μ Gold, G5=30μ Gold  
 Contact Finish: SI=5μ Gold/Tin, S2=5μ Gold/Tin, S3=10μ Gold/Tin, S4=50μ Gold/Tin, SS=30μ Gold/Tin, SN=Tin  
 Packing: T=Tube, R=Reel, R+CAP=Reel+CAP, 2=TYPE 2  
 Series No.: 1=TYPE 1, 2=TYPE 2

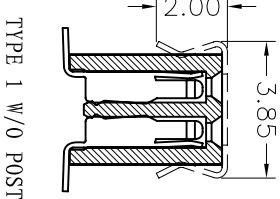


SECTION B-B

Special CAP for 2\*2pin



TYPE 2 WITH POST  
SECTION A-A



TYPE 1 W/O POST

TITLE	PART NO.
TYPE 1	2344-2XXMXXCUNT1
TYPE 2	2344-2XXMXXCUNT2

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM	TOL	APPROVE
A0	08/02/14	NEW					

OPERATION	DRAW	SCALE	UNIT	SIZE	SHEET	PROJ.
XX	DESIGN	5:1	mm	A4	1/1	Customer NO.
X.XXX	CHECK					
Angle						
± 3'						

**WCON** 维峰五金电子有限公司  
 WAFER HARDWARE ELECTRONICS CO. LTD

SEE TABLE

FH 1.27mm DUAL SWT H=4.30